

## CLAIM OR CLAIMS

1. A composition comprising solid particles of silicone resin with a glass transition temperature of more than 70 °C, the composition containing solid particles of silicone resin with a particle size distribution wherein (i) at least 90 volume percent of solid particles of silicone resin have an average major axis diameter of 40  $\mu\text{m}$  or less than 40  $\mu\text{m}$ , and (ii) at least 10 volume percent of solid particles of silicone resin have an average major axis diameter of 2  $\mu\text{m}$  or less.

2. A composition according to Claim 1 in which the silicone resin includes monovalent monofunctional M units ( $\text{R}_3\text{SiO}_{1/2}$ ), divalent difunctional D units ( $\text{R}_2\text{SiO}_{2/2}$ ), trivalent trifunctional T units ( $\text{RSiO}_{3/2}$ ), and tetravalent tetrafunctional Q units ( $\text{SiO}_{4/2}$ ), in which R is hydrogen, hydroxyl, a monovalent hydrocarbon group having 1-8 carbon atoms, an alkoxy group, or a substituted monovalent hydrocarbon group.

3. A composition according to Claim 2 in which the silicone resin contains only monovalent monofunctional M units ( $\text{R}_3\text{SiO}_{1/2}$ ) and tetravalent tetrafunctional Q units ( $\text{SiO}_{4/2}$ ) in which R is the same as defined in Claim 2.

4. A composition according to Claim 3 in which the silicone resin contains no more than about 15 mole percent hydroxyl as determined by Nuclear Magnetic Resonance, the number ratio or molar fraction of M units to Q units being in the range of 0.4:1 to 1.7:1, and the weight average Molecular weight of the silicone resin being 8,000-30,000 as determined by gel permeation chromatography.

5. A composition according to Claim 1 further comprising a liquid carrier into which the solid particles of silicone resin are dispersed, the liquid carrier being an aqueous based carrier or a non-aqueous based carrier, the liquid carrier being a non-solvent for solid particles of the silicone resin, non-solvency being that the liquid carrier is capable of dissolving only one percent or less of the solid particles of silicone resin at 70 °C.

6. A composition according to Claim 5 in which the liquid carrier is selected from the group consisting of water, diols, triols, glycerol esters, polyglycols, and mixtures thereof.

7. A composition according to Claim 5 in which the liquid carrier is selected from the group consisting of ethylene glycol, propylene glycol, glycerol, trimethylene glycol, and mixtures thereof.

8. A composition according to Claim 6 in which the liquid carrier is water, and the composition further comprises a surfactant.

9. A composition according to Claim 6 in which the liquid carrier is a diol, and the composition further comprises a compatible surfactant.

10. A composition according to Claim 1 which further comprises solid particles of an inorganic material blended with the solid particles of silicone resin.